

VOLTAGE-CONTROLLED CRYSTAL OSCILLATOR (VCXO)

OUTPUT : LVDS



Product Number
 VG3225VFN X1G005461xxxx00
 VG5032VFN X1G005481xxxx00
 VG7050VFN X1G005501xxxx00

VG3225VFN
VG5032VFN
VG7050VFN



- Frequency range : 25 MHz to 250 MHz
 - Supply voltage : 3.3 V
 - Absolute pull range : 20×10^{-6} Min. / 50×10^{-6} Min.
 - Operating temperature: -40 °C to +85 °C / -40 °C to +105 °C
 - Function : Output enable (OE)
 - Output : LVDS
- VG5032VFN

Specifications (characteristics)

Item	Symbol	Specifications	Conditions / Remarks
Output frequency range	f _o	25 MHz to 250 MHz	Please contact us for inquiries regarding available frequencies.
Supply voltage	V _{CC}	3.3 V ±0.165 V	
Control voltage*	V _C	1.65 V ±1.65 V	
Storage temperature	T _{stg}	-55 °C to +125 °C	Store as bare product.
Operating temperature	T _{use}	G: -40 °C to +85 °C, H: -40 °C to +105 °C	
Frequency tolerance	f _{tol}	±50 × 10 ⁻⁶ Max.	V _C =1.65 V Includes initial frequency tolerance, temperature variation, supply voltage change and 10 years aging at +25 °C.
Absolute Pull range *1	APR	±50 × 10 ⁻⁶ Min.	25 MHz to 42.5 MHz, 50 MHz to 85 MHz, 100 MHz to 170 MHz
		±20 × 10 ⁻⁶ Min.	25 MHz to 250 MHz
Current consumption	I _{CC}	25 mA Max.	OE= V _{CC} , with output load
Input resistance	R _{in}	10 MΩ Min.	DC level
Frequency change polarity Symmetry	- SYM	Positive slope 45 % to 55 %	V _C = 0 V to 3.3 V at outputs crossing point
Output voltage	V _{OD1} , V _{OD2}	250 mV to 450 mV	DC characteristics
	V _{OS1} , V _{OS2}	1.15 V to 1.35 V	
Output load condition	L _{LVDS}	100 Ω	Connected between OUT to $\bar{O}UT$
Input voltage	V _{IH}	70 % V _{CC} Min.	OE terminal
	V _{IL}	30 % V _{CC} Max.	
Rise/Fall times	t _r / t _f	0.3 ns Max.	at 20 % and 80 % of Differential Output peak to peak voltage
Oscillation start up time	t _{str}	10 ms Max.	Time at minimum supply voltage to be 0 s
Phase Jitter	t _{pj}	160 fs Max. (122.88 MHz) 80 fs Max. (245.76 MHz)	Offset Frequency 12 kHz to 20 MHz

*1 Absolute pull range = Frequency control range- Frequency tolerance

* Please keep V_C pin open or ground while powering up V_{CC}.

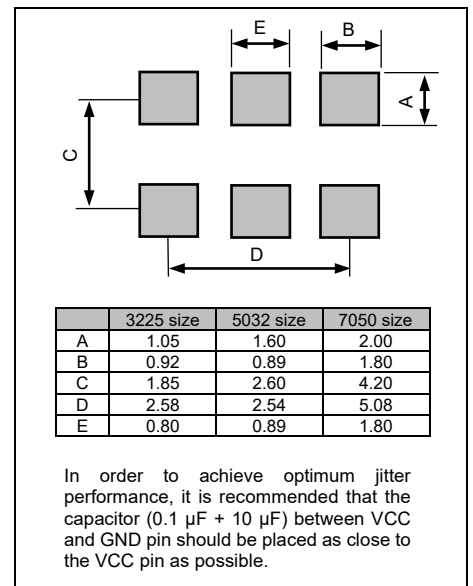
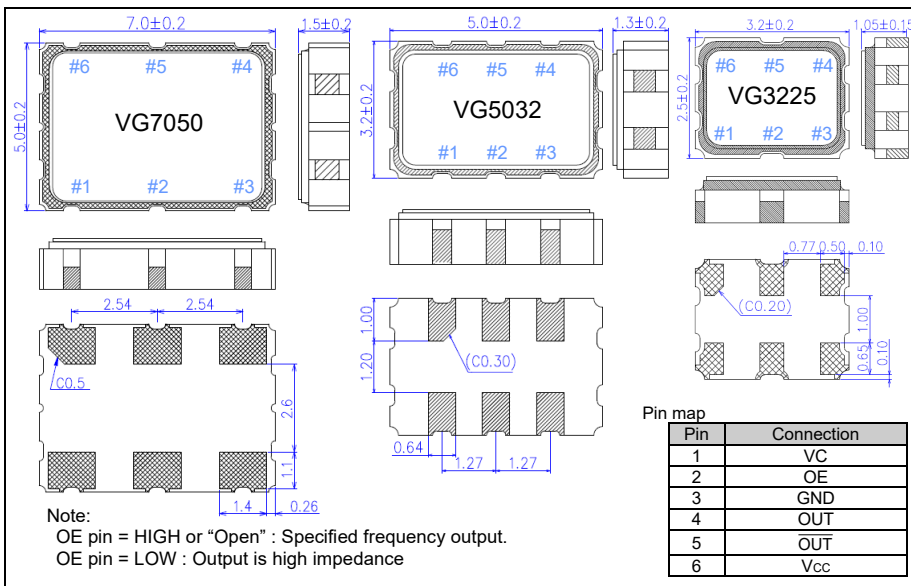
Product name (Standard form) **VG3225 VFN 122.880000 MHz** C J G H B A
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨
 ① Model ② Output (V: LVDS) ③ Frequency ④ Supply voltage (C: 3.3 V Typ.)
 ⑤ Frequency tolerance (J: ±50 × 10⁻⁶ Max.) ⑥ Operating temperature (G: -40 °C to +85 °C, H: -40 °C to +105 °C)
 ⑦ OE Function (H: Active High) ⑧ Absolute Pull Range (B: ±50 × 10⁻⁶ Min.) ⑨ Output Standby Type (A: High-Z)

External dimensions

(Unit:mm)

Footprint (Recommended)

(Unit:mm)



PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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